

BTA40, BTA41, BTB41

40 A standard TRIACs

Features

- High current TRIAC
- Low thermal resistance with clip bonding
- High commutation capability
- BTA series UL1557 certified (File ref: 81734)
- Packages are RoHS (2002/95/EC) compliant

Applications

- On/off function in static relays, heating regulation, induction motor starting circuits
- Phase control operations in light dimmers, motor speed controllers, and similar

Description

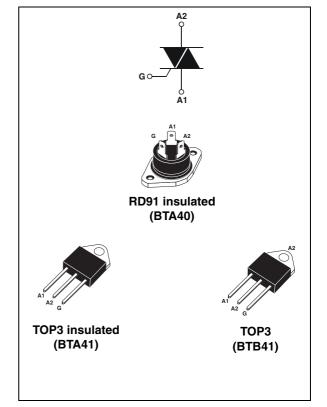
Available in high power packages, the BTA/BTB40-41 series is suitable for general purpose AC switching.

The BTA series provides an insulated tab (rated at 2500 V rms).

Table 1. Device summary

Symbol	Parameter	BTA40 ⁽¹⁾	BTA41 ⁽¹⁾	BTB41	Unit
I _{T(RMS)}	On-state rms current	40	41	41	А
V _{DRM} /V _{RRM}	Repetitive peak off-state voltage	600 and 800	600 and 800	600 and 800	V
I _{GT}	Triggering gate current	50	50	50	mA

1. Insulated package



1 Characteristics

Symbol	Paramo		Value	Unit	
	On-state rms current	TOP3 T _c = 95 °C		40	А
I _{T(RMS)}	(full sine wave)	RD91 / TOP ins.	T _c = 80 °C	40	A
	Non repetitive surge peak on-state	F = 50 Hz	t = 20 ms	400	А
I _{TSM}	current (full cycle, T _j initial = 25 °C)	F = 60 Hz	t = 16.7 ms	420	A
l ² t	I ² t Value for fusing	t _p = 10 ms	1000	A ² s	
dl/dt	Critical rate of rise of on-state current I_G = 2 x I_{GT} , t_r \leq 100 ns	F = 120 Hz T _j = 125 °C		50	A/µs
V _{DSM} /V _{RSM}	Non repetitive surge peak off-state voltage $t_p = 10 \text{ ms}$ $T_j = 25 \text{ °C}$		V _{DSM} /V _{RSM} + 100	V	
I _{GM}	Peak gate current $t_p = 20 \ \mu s$ $T_j = 125 \ ^{\circ}C$		8	А	
P _{G(AV)}	Average gate power dissipation	1	W		
T _{stg} T _j	Storage junction temperature range Operating junction temperature range	- 40 to + 150 - 40 to + 125	°C		

Table 2. Absolute maximum ratings

Table 3.Electrical characteristics ($T_j = 25$ °C, unless otherwise specified)

Symbol	Parame	Parameter				
I _{GT} ⁽¹⁾	$V_D = 12 V$ $R_L = 33 \Omega$	$R_L = 33 \Omega$ I - II - III MAX.		50 100	mA	
V _{GT}		ALL	MAX.	1.3	V	
V _{GD}	$V_D = V_{DRM}$ $R_L = 3.3 \text{ k}\Omega$ $T_j = 125 \text{ °C}$ ALL		MIN.	0.2	V	
I _H (2)	I _T = 500 mA		MAX.	80	mA	
I	1 _ 1 2 1	I - III - IV	MAX.	70	mA	
۱Ľ	I_{L} $I_{G} = 1.2 I_{GT}$			160	IIIA	
dV/dt ⁽²⁾	$V_D = 67\% V_{DRM}$ gate open	T _j = 125 °C	MIN.	500	V/µs	
(dV/dt)c ⁽²⁾	(dl/dt)c = 20 A/ms	T _j = 125 °C	MIN.	10	V/µs	

1. Minimum I_{GT} is guaranted at 5% of I_{GT} max.

2. for both polarities of A2 referenced to A1



Symbol	Test conc	Test conditions				
V _T ⁽¹⁾	$I_{TM} = 60 \text{ A}$ $t_p = 380 \mu \text{s}$	T _j = 25 °C	MAX.	1.55	V	
V _{t0} ⁽²⁾	Threshold voltage	T _j = 125 °C	MAX.	0.85	V	
R _d ⁽²⁾	Dynamic resistance	T _j = 125 °C	MAX.	10	mΩ	
I _{DRM}	<u> </u>	T _j = 25 °C	MAX.	5	μA	
I _{RRM}	$V_{DRM} = V_{RRM}$	T _j = 125 °C		5	mA	

Table 4.Static characteristics

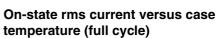
1. Minimum I_{GT} is guaranted at 5% of I_{GT} max.

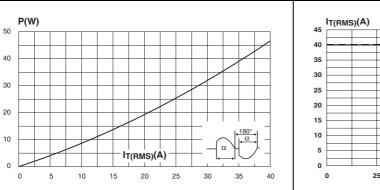
2. for both polarities of A2 referenced to A1

Table 5.Thermal resistance

Symbol	Test o	Value	Unit	
P	Junction to case (AC)	RD91 (insulated) / TOP3 insulated	0.9	°C/W
R _{th(j-c)}	JUNCION IO CASE (AC)	ТОР3	0.6	0/11
R _{th(j-a)}	Junction to ambient TOP3 / TOP3 insulated		50	°C/W

Figure 1. Maximum power dissipation versus Figure 2. on-state rms current (full cycle)





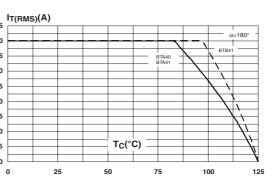


Figure 3. Relative variation of thermal impedance versus pulse duration

Figure 4. On-state characteristics (maximum values)

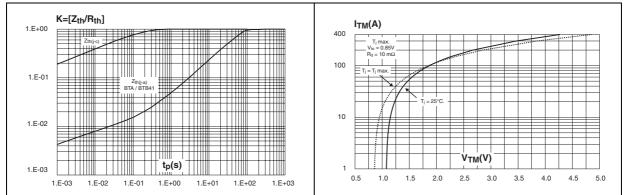
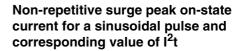
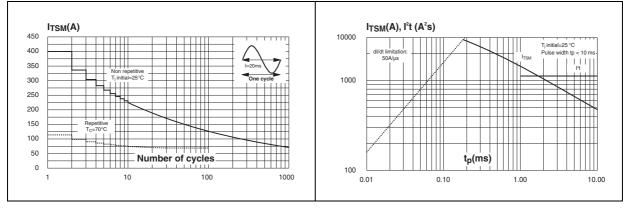
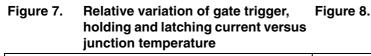




Figure 5. Surge peak on-state current versus Figure 6. number of cycles







Relative variation of critical rate of decrease of main current versus (dV/dt)c (typical values)

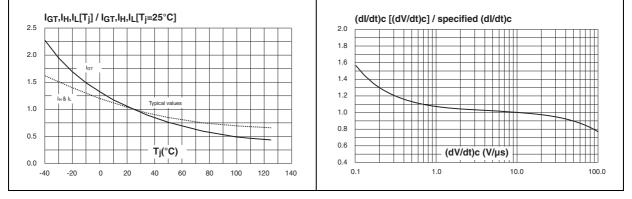
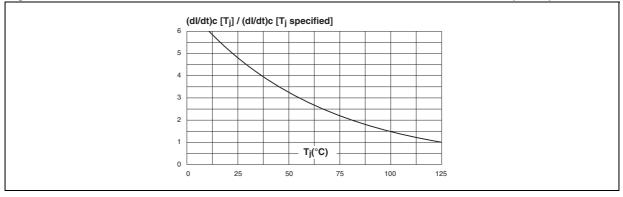


Figure 9. Relative variation of critical rate of decrease of main current versus (dV/dt)c





2 Ordering information scheme

Figure 10. Ordering information scheme

	BT A 40 - 600 B RG
TRIAC series	
Insulation A = insulated B = non-insulated	
Current 40 = 40 A in RD91	
Voltage 600 = 600 V 800 = 800 V	
Sensitivity and type B = 50 mA standard	
Packing mode RG = Tube Blank = Bulk	



3 Package information

- Epoxy meets UL94, V0
- Lead-free packages

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK[®] is an ST trademark.

Table 6.TOP3 insulated and non-insulated dimensions

				Dimer	nsions	
		Ref.	Millin	neters	Inc	hes
<u>⊬ H</u>	A		Min.	Max.	Min.	Max.
R ØL	B	Α	4.4	4.6	0.173	0.181
		В	1.45	1.55	0.057	0.061
κ[]		С	14.35	15.60	0.565	0.614
		D	0.5	0.7	0.020	0.028
F G		Е	2.7	2.9	0.106	0.114
		F	15.8	16.5	0.622	0.650
		G	20.4	21.1	0.815	0.831
P→← C		н	15.1	15.5	0.594	0.610
	-	J	5.4	5.65	0.213	0.222
JJJ		К	3.4	3.65	0.134	0.144
	E	ØL	4.08	4.17	0.161	0.164
		Р	1.20	1.40	0.047	0.055
		R	4.60) typ.	0.18	1 typ.



			Dimer	nsions	
	Ref.	ef. Millimeters		Inches	
		Min.	Max.	Min.	Max.
L2 A2	Α	-	40.00	-	1.575
	A1	29.90	30.30	1.177	1.193
	A2	-	22.00	-	0.867
	В	-	27.00	-	1.063
	B1	13.50	16.50	0.531	0.650
	B2	-	24.00	-	0.945
	С	-	14.00	-	0.551
	C1	-	3.50	-	0.138
N2	C2	1.95	3.00	0.077	0.118
	E3	0.70	0.90	0.027	0.035
	F	4.00	4.50	0.157	0.177
	I	11.20	13.60	0.441	0.535
← A	L1	3.10	3.50	0.122	0.138
	L2	1.70	1.90	0.067	0.075
	N1	33°	43°	33°	43°
	N2	28°	38°	28°	38°

Table 7.RD91 dimensions



4 Ordering information

Table 8.Ordering information

Order code ⁽¹⁾	Marking	Package	Weight	Base qty	Delivery mode
BTA40-xxxB	BTA40xxxB	RD91	20 g	25	Bulk
BTA41-xxxBRG	BTA41xxxB	TOP3 Ins.	4.5 g	30	Tube
BTB41-xxxBRG	BTB41xxxB	TOP3	4.5 g	30	Tube

1. xxx = voltage

5 Revision history

Date	Revision	Changes
Sep-2003	5	Last update.
25-Mar-2005	6	TOP3 delivery mode changed from bulk to tube.
14-Oct-2005	7	${\rm T_c}$ values for ${\rm I_T}$ changed in Table 3. ECOPACK statement added.
10-Aug-2009	8	Updated <i>Table 2</i> to correctly place packages. Updated <i>Figure 2. Table 5</i> changed to correctly place TOP3. Updated ECOPACK statement.

Table 9. Document revision history



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